CEP8030L/CEB8030L

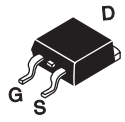
PRELIMINARY

4

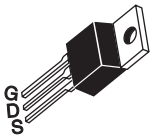
N-Channel Logic Level Enhancement Mode Field Effect Transistor

FEATURES

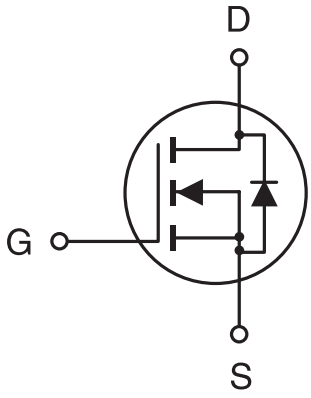
- 30V , 75A , $R_{DS(ON)}$=6mΩ @V_{GS}=10V.
  $R_{DS(ON)}$=9mΩ @V_{GS}=4.5V.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- TO-220 & TO-263 package.



CEB SERIES
TO-263(DD-PAK)



CEP SERIES
TO-220



ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±16	V
Drain Current-Continuous	I_D	75	A
-Pulsed	I_{DM}	156	A
Drain-Source Diode Forward Current	I_S	75	A
Maximum Power Dissipation @Tc=25°C	P_D	50	W
Derate above 25°C		0.4	W/°C
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to 175	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250μA	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=24V, V_{GS} =0V			10	μA
Gate-Body Leakage	I_{GSS}	V_{GS} =±16V, V_{DS}=0V			±100	nA
ON CHARACTERISTICS[a]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D = 250μA	1		3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 37.5A			6	mΩ
		V_{GS} = 4.5V, I_D = 30A			9	mΩ
On-State Drain Current	$I_{D(ON)}$	V_{GS} = 10V, V_{DS} = 10V	75			A
Forward Transconductance	g_{FS}	V_{DS} = 10V, I_D = 26A		32		S
DYNAMIC CHARACTERISTICS[b]						
Input Capacitance	C_{ISS}	V_{DS} =15V, V_{GS} = 0V f =1.0MHz		3898	5100	pF
Output Capacitance	C_{OSS}			1876	2500	pF
Reverse Transfer Capacitance	C_{RSS}			270	350	pF
SWITCHING CHARACTERISTICS[b]						
Turn-On Delay Time	$t_{D(ON)}$	V_{DD} = 15V, I_D = 52A, V_{GS}= 10V R_{GEN} = 24Ω		10	16	ns
Rise Time	t_r			200	250	ns
Turn-Off Delay Time	$t_{D(OFF)}$			50	90	ns
Fall Time	t_f			140	200	ns
Total Gate Charge	Q_g	V_{DS} =10V, I_D = 52A, V_{GS} =10V		44	60	nC
Gate-Source Charge	Q_{gs}			6		nC
Gate-Drain Charge	Q_{gd}			14		nC

ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS [a]						
Diode Forward Voltage	V_{SD}	V_{GS} = 0V, Is =37.5A		0.9	1.3	V

Notes

a.Pulse Test:Pulse Width ≤300 μs, Duty Cycle ≤ 2%.
b.Guaranteed by design, not subject to production testing.

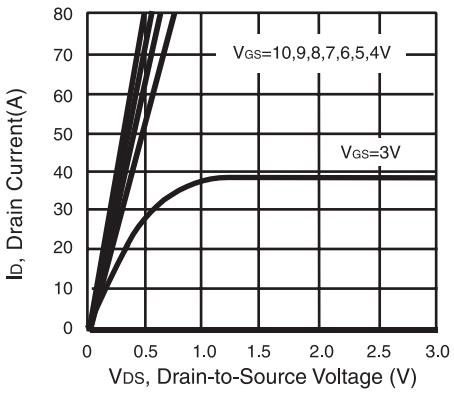


Figure 1. Output Characteristics

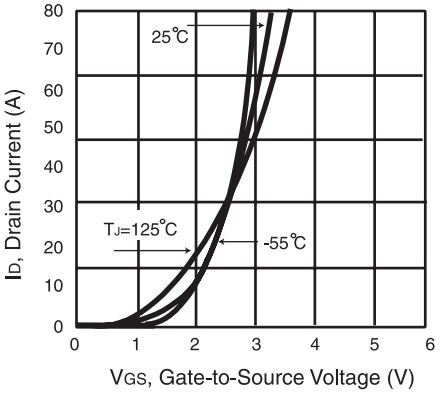


Figure 2. Transfer Characteristics

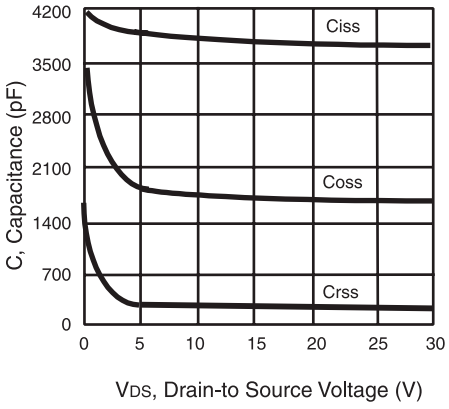


Figure 3. Capacitance

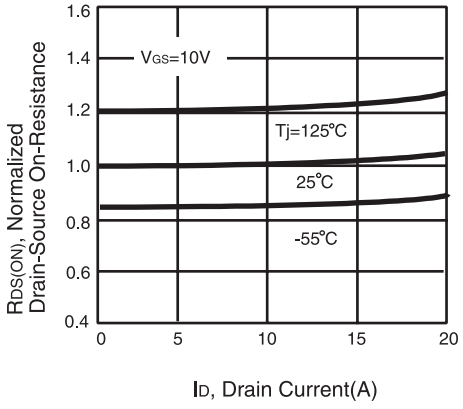


Figure 4. On-Resistance Variation with Drain Current and Temperature

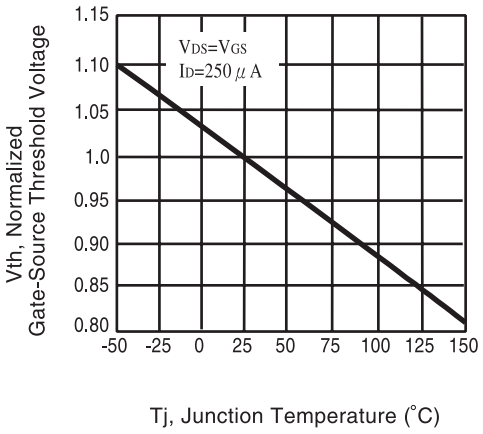


Figure 5. Gate Threshold Variation with Temperature

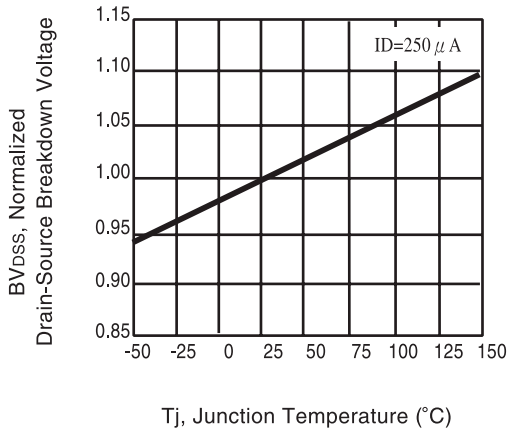


Figure 6. Breakdown Voltage Variation with Temperature

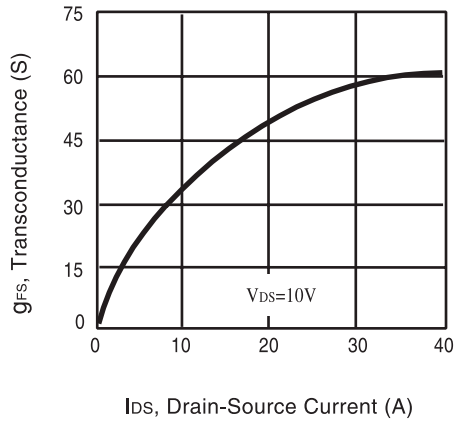


Figure 7. Transconductance Variation with Drain Current

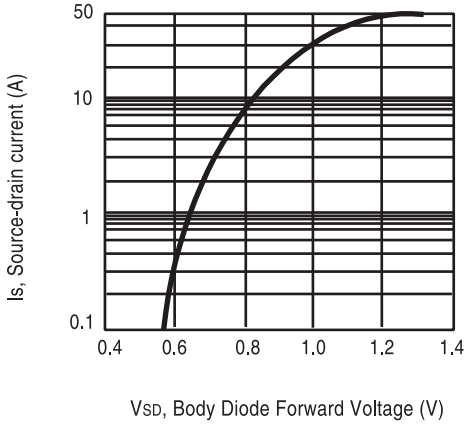


Figure 8. Body Diode Forward Voltage Variation with Source Current

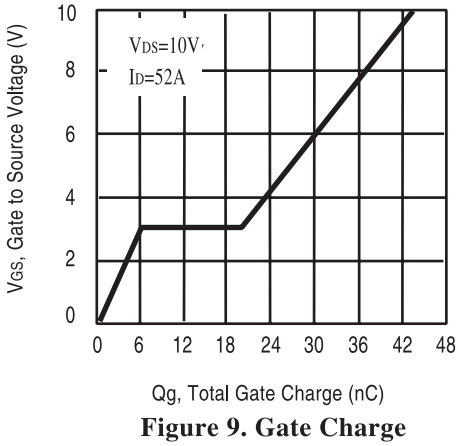


Figure 9. Gate Charge

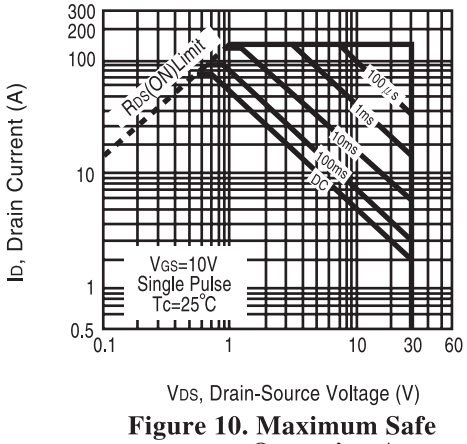


Figure 10. Maximum Safe Operating Area

4

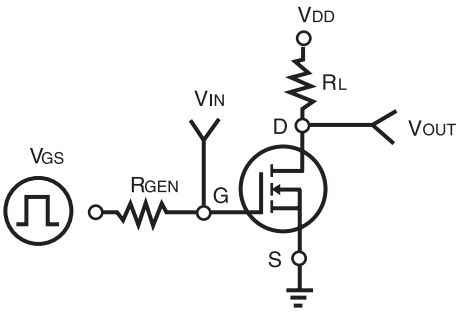


Figure 11. Switching Test Circuit

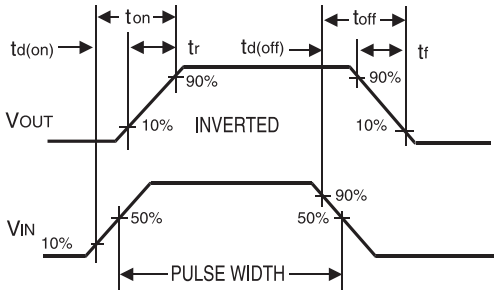


Figure 12. Switching Waveforms

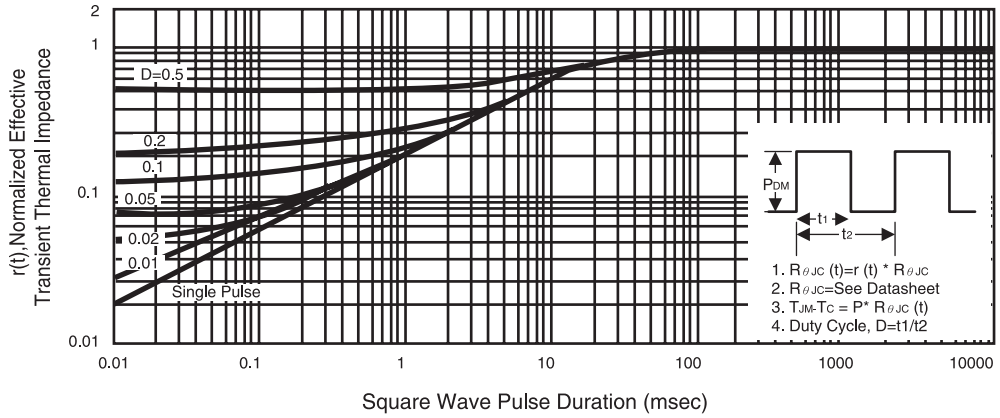


Figure 13. Normalized Thermal Transient Impedance Curve